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PATENT NUMBER and
ISSUE DATE

U.S. UTILITY Patent Application

APPL NUM 10082554	FILING DATE 02/25/2002	CLASS 257 430	SUBCLASS 763	GAU 26 28	EXAMINER Horne
**APPLICANTS: Bauch Lothar; Zell Thomas; Lehr Matthias; Kieslich Albrecht;					
**CONTINUING DATA VERIFIED: THIS APPLICATION IS A CON OF PCT/DE00/02854 08/23/2000					
** FOREIGN APPLICATIONS VERIFIED: GERMANY 199 39 852.6 08/23/1999					
PG-PUB <input type="checkbox"/>		DO NOT PUBLISH <input type="checkbox"/>		RESCIND <input type="checkbox"/>	
Foreign priority claimed <input type="checkbox"/> yes <input type="checkbox"/> no 35 USC 119 conditions met <input type="checkbox"/> yes <input type="checkbox"/> no Verified and Acknowledged Examiners's initials				ATTORNEY DOCKET NO 1999P2628	
TITLE : Stacked via with specially designed landing pad for integrated semiconductor structures					

NOTICE OF ALLOWANCE MAILED		CLAIMS ALLOWED	
		Total Claims	Print Claim for O.G
ISSUE FEE		DRAWING	
Amount Due	Date Paid	Sheets Drwg.	Figs.Drwg. Print Fig.
		Applicati n Examiner	
<input type="checkbox"/> TERMINAL DISCLAIMER		PREPARED FOR ISSUE	
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